

## Octal channel high side driver

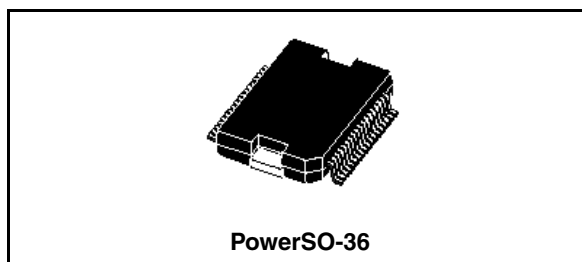
### Features

| Type         | $R_{DS(on)}$   | $I_{out}$ | $V_{CC}$ |
|--------------|----------------|-----------|----------|
| VN808CM-32-E | 160 m $\Omega$ | 1 A       | 45 V     |

- CMOS compatible input
- Junction over-temperature protection
- Case over-temperature protection for thermal independence of the channels
- Current limitation
- Shorted load protection
- Undervoltage shut-down
- Protection against loss of ground
- Very low stand-by current
- Compliance to 61000-4-4 IEC test up to 4 kV

### Description

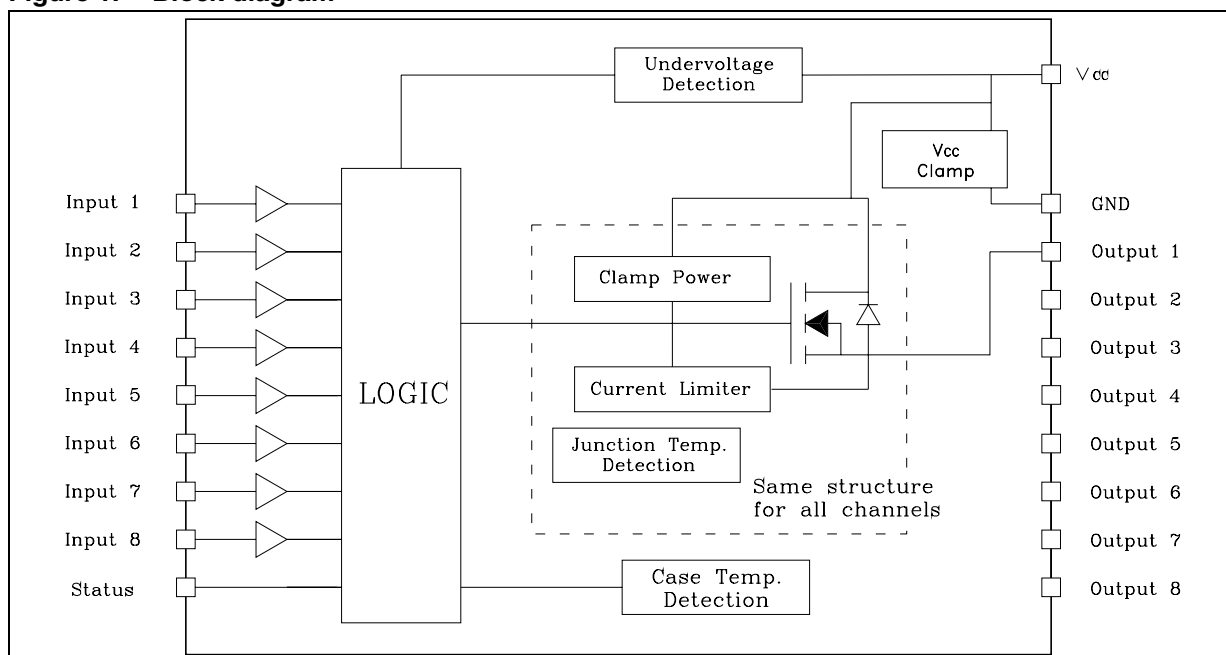
The VN808CM-32-E is a monolithic device designed in STMicroelectronics VIPower M0-3 technology, intended for driving any kind of load with one side connected to ground.



It can be driven by using a 3.3 V logic supply.

Active current limitation combined with thermal shutdown and automatic restart, protect the device against overload. In overload condition, channel turns OFF and back ON automatically so as to maintain junction temperature between  $T_{TSD}$  and  $T_R$ . If this condition makes case temperature reach  $T_{CSD}$ , overloaded channel is turned OFF and will restart only when case temperature has decreased down to  $T_{CR}$  (see waveform 3 [Figure 6 on page 10](#)). Non overloaded channels continue to operate normally. Device automatically turns OFF in case of ground pin disconnection. This device is especially suitable for industrial applications conform to IEC 61131

**Figure 1. Block diagram**



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# 1 Maximum ratings

**Table 1. Absolute maximum rating**

| Symbol     | Parameter  | Value              | Unit             |
|------------|--|--------------------|------------------|
| $V_{CC}$   | DC supply voltage  | 45                 | V                |
| $-I_{GND}$ | DC ground pin reverse current<br>TRAN ground pin reverse current<br>(pulse duration < 1ms)                           | -250<br>-6         | mA<br>A          |
| $I_{OUT}$  | DC output current  | Internally limited | A                |
| $-I_{OUT}$ | Reverse DC output current  | -2                 | A                |
| $I_{IN}$   | DC Input current   | $\pm 10$           | mA               |
| $V_{ESD}$  | Electrostatic discharge (R = 1.5 k $\Omega$ ; C = 100 pF)  | 2000               | V                |
| $P_{TOT}$  | Power dissipation at $T_C = 25\text{ }^\circ\text{C}$  | 96                 | W                |
| $L_{MAX}$  | Max inductive load ( $V_{CC} = 24\text{ V}$ , $R_{LOAD} = 48\text{ }\Omega$ ,<br>$T_A = 100\text{ }^\circ\text{C}$ ) | 2                  | H                |
| $T_J$      | Junction operating temperature   | Internally limited | $^\circ\text{C}$ |
| $T_C$      | Case operating temperature   | Internally limited | $^\circ\text{C}$ |
| $T_{STG}$  | Storage temperature  | -40 to 150         | $^\circ\text{C}$ |

**Table 2. Thermal data**

| Symbol     | Parameter  | Value   | Unit               |
|------------|--|---------|--------------------|
| $R_{thJC}$ | Thermal resistance junction-case                   | Max 1.3 | $^\circ\text{C/W}$ |
| $R_{thJA}$ | Thermal resistance junction-ambient <sup>(1)</sup> | Max 50  | $^\circ\text{C/W}$ |

1. When mounted on FR4 printed circuit board with 0.5 cm<sup>2</sup> of copper area (at least 35  $\mu\text{m}$  thick) connected to all TAB pins.

## 2 Electrical characteristics

(10.5 V < V<sub>CC</sub> < 32 V; -40 °C < T<sub>J</sub> < 125 °C; unless otherwise specified)

**Table 3. Power section**

| Symbol                | Parameter  | Test conditions  | Min  | Typ | Max        | Unit     |
|-----------------------|--|--|------|-----|------------|----------|
| V <sub>CC</sub>       | Operating supply voltage                             |  | 10.5 |     | 45         | V        |
| V <sub>USD</sub>      | Undervoltage shutdown                                |  | 7    |     | 10.5       | V        |
| R <sub>ON</sub>       | On state resistance                                  | I <sub>OUT</sub> = 0.5 A; T <sub>J</sub> = 25 °C<br>I <sub>OUT</sub> = 0.5 A;  |      |     | 160<br>280 | mΩ<br>mΩ |
| I <sub>S</sub>        | Supply current                                       | OFF state; V <sub>CC</sub> = 24 V;<br>T <sub>CASE</sub> = 25 °C<br>ON state (all channels ON);<br>V <sub>CC</sub> = 24 V, T <sub>CASE</sub> = 100 °C |      |     | 150<br>12  | μA<br>mA |
| I <sub>LGND</sub>     | Output current at turn-off                           | V <sub>CC</sub> = V <sub>STAT</sub> = V <sub>IN</sub> = V <sub>GND</sub> = 24 V<br>V <sub>OUT</sub> = 0 V  |      |     | 1          | mA       |
| I <sub>L(off)</sub>   | OFF state output current                             | V <sub>IN</sub> = V <sub>OUT</sub> = 0 V;  | 0    |     | 5          | μA       |
| V <sub>OUT(off)</sub> | OFF state output voltage                             | V <sub>IN</sub> = 0 V, I <sub>OUT</sub> = 0 A  |      |     | 3          | V        |
| t <sub>d(Vccon)</sub> | Power-on delay time from V <sub>CC</sub> rising edge | <i>Figure 7 on page 12</i>   |      | 1   |            | ms       |

**Table 4. Switching (V<sub>CC</sub> = 24 V)**

| Symbol                                 | Parameter              | Test conditions  | Min | Typ | Max | Unit |
|--|------------------------|--|-----|-----|-----|------|
| t <sub>ON</sub>                        | Turn-on time           | R <sub>L</sub> = 48 Ω from 80 %<br>V <sub>OUT</sub> <i>Figure 4.</i>                                 |     | 50  | 100 | μs   |
| t <sub>OFF</sub>                       | Turn-off time          | R <sub>L</sub> = 48 Ω to 10 % V <sub>OUT</sub> <i>Figure 4.</i>                                      |     | 75  | 150 | μs   |
| dV <sub>OUT</sub> /dt <sub>(on)</sub>  | Turn-on voltage slope  | R <sub>L</sub> = 48 Ω from V <sub>OUT</sub> = 2.4 V to<br>V <sub>OUT</sub> = 19.2 V <i>Figure 4.</i> |     | 0.7 |     | V/μs |
| dV <sub>OUT</sub> /dt <sub>(off)</sub> | Turn-off voltage slope | R <sub>L</sub> = 48 Ω from V <sub>OUT</sub> = 21.6 V to<br>V <sub>OUT</sub> = 2.4 V <i>Figure 4.</i> |     | 1.5 |     | V/μs |

**Table 5. Input pin**

| Symbol        | Parameter                | Test conditions                                   | Min  | Typ         | Max  | Unit          |
|---------------|--------------------------|---|------|-------------|------|---------------|
| $V_{INL}$     | Input low level          |   |      |             | 1.25 | V             |
| $I_{INL}$     | Low level input current  | $V_{IN} = 1.25\text{ V}$                          | 1    |             |      | $\mu\text{A}$ |
| $V_{INH}$     | Input high level         |   | 2.25 |             |      | V             |
| $I_{INH}$     | High level input current | $V_{IN} = 2.25\text{ V}$                          |      |             | 10   | $\mu\text{A}$ |
| $V_{I(HYST)}$ | Input hysteresis voltage |   | 0.25 |             |      | V             |
| $V_{ICL}$     | Input clamp voltage      | $I_{IN} = 1\text{ mA}$<br>$I_{IN} = -1\text{ mA}$ | 6.0  | 6.8<br>-0.7 | 8.0  | V<br>V        |

**Table 6. Protections**

| Symbol      | Parameter                     | Test conditions   | Min         | Typ         | Max         | Unit               |
|-------------|-------------------------------|---|-------------|-------------|-------------|--------------------|
| $T_{CSD}$   | Case shut-down temperature    |   | 125         | 130         | 135         | $^{\circ}\text{C}$ |
| $T_{CR}$    | Case reset temperature        |   | 110         |             |             | $^{\circ}\text{C}$ |
| $T_{CHYST}$ | Case thermal hysteresis       |   | 7           | 15          |             | $^{\circ}\text{C}$ |
| $T_{TSD}$   | Junction shutdown temperature |   | 150         | 175         | 200         | $^{\circ}\text{C}$ |
| $T_R$       | Junction reset temperature    |   | 135         |             |             | $^{\circ}\text{C}$ |
| $T_{HYST}$  | Junction thermal hysteresis   |   | 7           | 15          |             | $^{\circ}\text{C}$ |
| $I_{lim}$   | DC Short circuit current      | $V_{CC} = 24\text{ V}$ ; $R_{LOAD} = 10\text{ m}\Omega$ | 1           |             | 1.7         | A                  |
| $V_{demag}$ | Turn-off output clamp voltage | $I_{OUT} = 0.5\text{ A}$ ; $L = 6\text{ mH}$            | $V_{CC}-57$ | $V_{CC}-52$ | $V_{CC}-47$ | V                  |

**Table 7. Status pin**

| Symbol       | Parameter                 | Test conditions  | Min | Typ         | Max | Unit          |
|--------------|---------------------------|--|-----|-------------|-----|---------------|
| $I_{HSTAT}$  | High level output current | $V_{CC} = 18\dots32\text{ V}$ ; $R_{STAT} = 1\text{ k}\Omega$<br>(Fault condition) | 2   | 3           | 4   | mA            |
| $I_{LSTAT}$  | Leakage current           | Normal operation; $V_{CC} = 32\text{ V}$   |     |             | 0.1 | $\mu\text{A}$ |
| $V_{CLSTAT}$ | Clamp voltage             | $I_{STAT} = 1\text{ mA}$<br>$I_{STAT} = -1\text{ mA}$                              | 6.0 | 6.8<br>-0.7 | 8.0 | V<br>V        |

### 3 Pin connections

Figure 2. Connection diagram (top view)



Table 8. Pin functions

| Pin N°         | Symbol          | Function   |
|----------------|-----------------|--|
| TAB            | V <sub>CC</sub> | Positive power supply voltage                      |
| 1              | V <sub>CC</sub> | Positive power supply voltage                      |
| 2,3,4,5        | NC              | Not connected                                      |
| 6              | Input 1         | Input of channel 1                                 |
| 7              | Input 2         | Input of channel 2                                 |
| 8              | Input 3         | Input of channel 3                                 |
| 9              | Input 4         | Input of channel 4                                 |
| 10             | Input 5         | Input of channel 5                                 |
| 11             | Input 6         | Input of channel 6                                 |
| 12             | Input 7         | Input of channel 7                                 |
| 13             | Input 8         | Input of channel 8                                 |
| 14,15,16,17,18 | NC              | Not connected                                      |
| 19             | GND             | Logic ground                                       |
| 20             | STATUS          | Common open source diagnostic for over-temperature |
| 21,22          | Output 8        | High-side output of channel 8                      |
| 23,24          | Output 7        | High-side output of channel 7                      |

**Table 8. Pin functions (continued)**

| Pin N° | Symbol   | Function                      |
|--------|----------|-------------------------------|
| 25,26  | Output 6 | High-side output of channel 6 |
| 27,28  | Output 5 | High-side output of channel 5 |
| 29,30  | Output 4 | High-side output of channel 4 |
| 31,32  | Output 3 | High-side output of channel 3 |
| 33,34  | Output 2 | High-side output of channel 2 |
| 35,36  | Output 1 | High-side output of channel 1 |

## 4 Current, voltage conventions and truth table

Figure 3. Current and voltage conventions

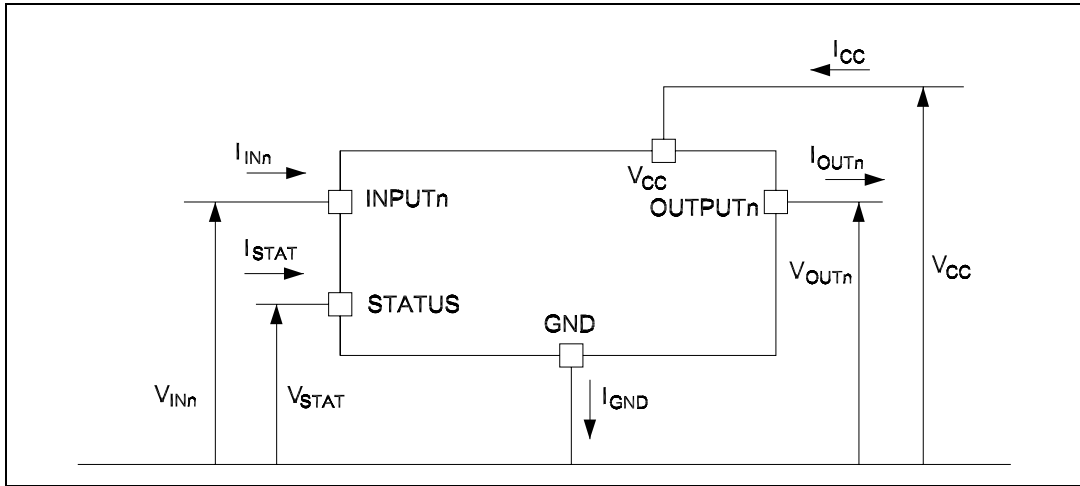


Table 9. Truth table

| Conditions   | INPUTn | OUTPUTn | STATUS |
|--|--------|---------|--------|
| Normal operation   | L      | L       | L      |
|  | H      | H       | L      |
| Current limitation   | L      | L       | L      |
|  | H      | X       | L      |
| Overtemperature<br>(see waveforms 3, 4 <a href="#">Figure 6</a> ) -> $T_J > T_{TSD}$ | L      | L       | L      |
|  | H      | L       | H      |
| Undervoltage   | L      | L       | X      |
|  | H      | L       | X      |



## 5 Switching time waveforms

Figure 4. Turn-ON and turn-OFF

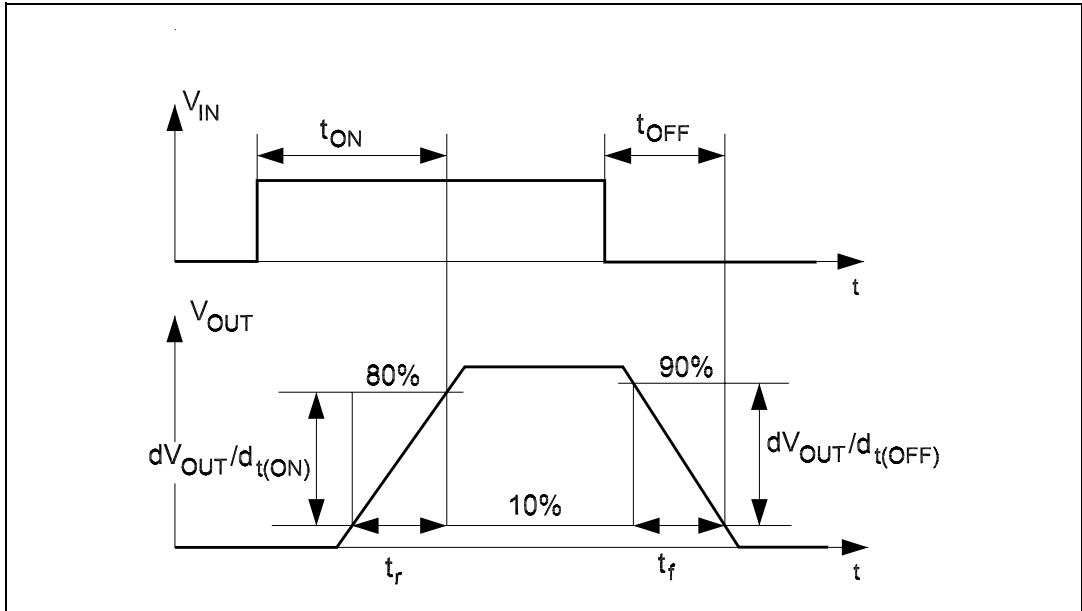


Figure 5. V<sub>CC</sub> turn-ON

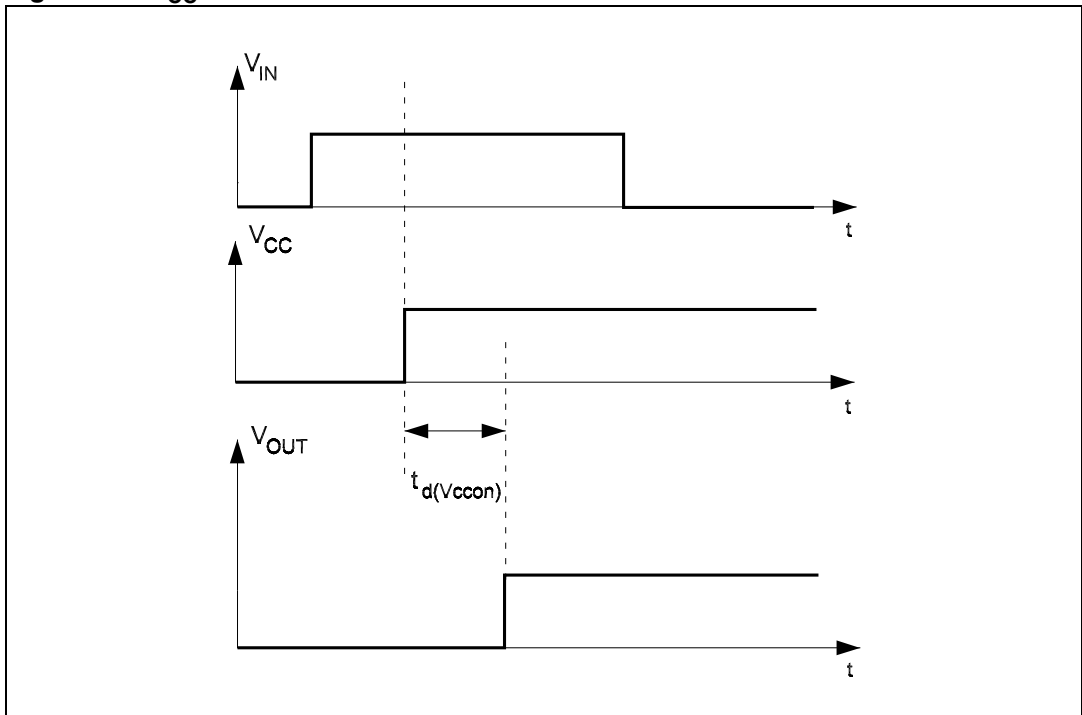


Figure 6. Waveforms

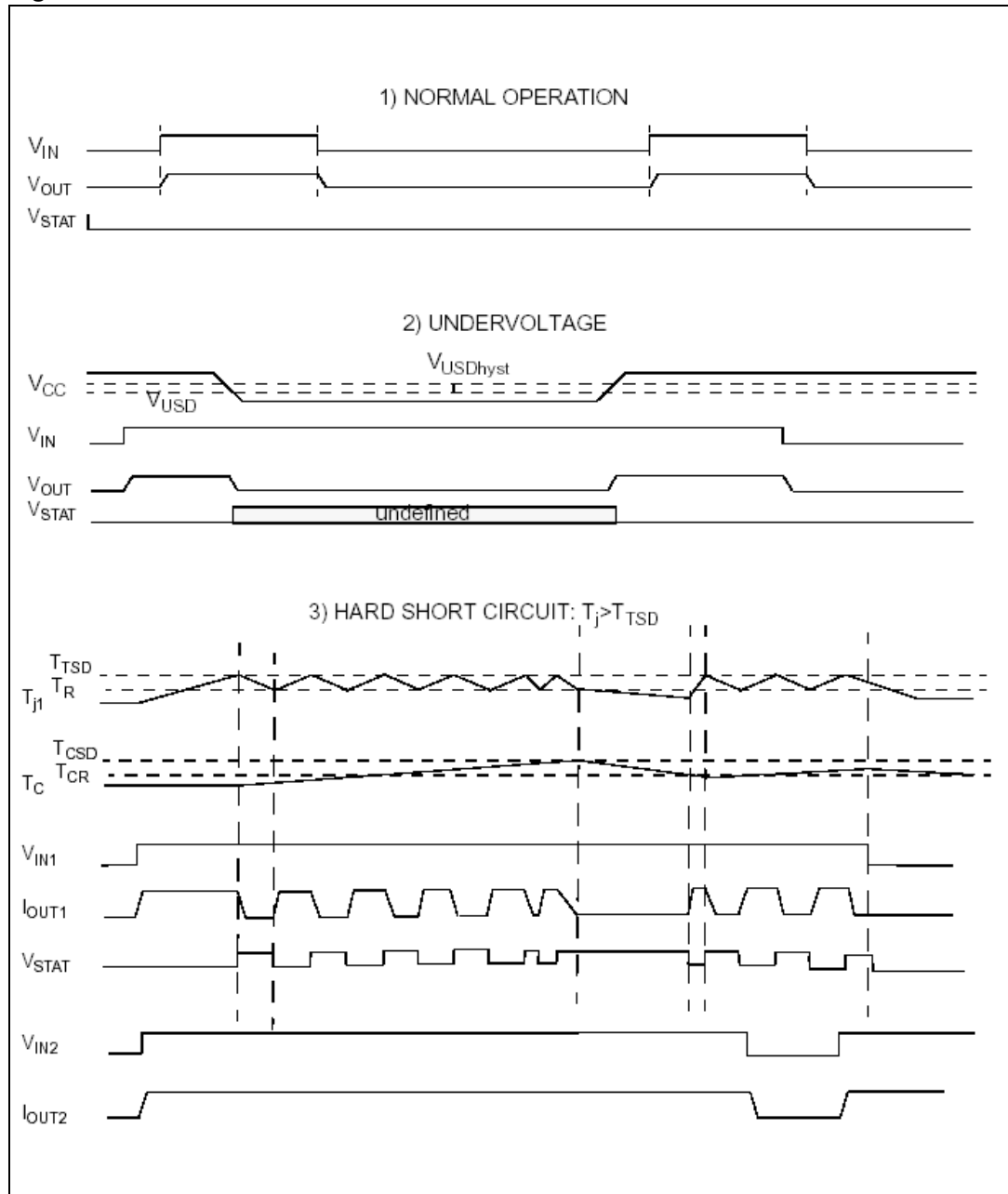
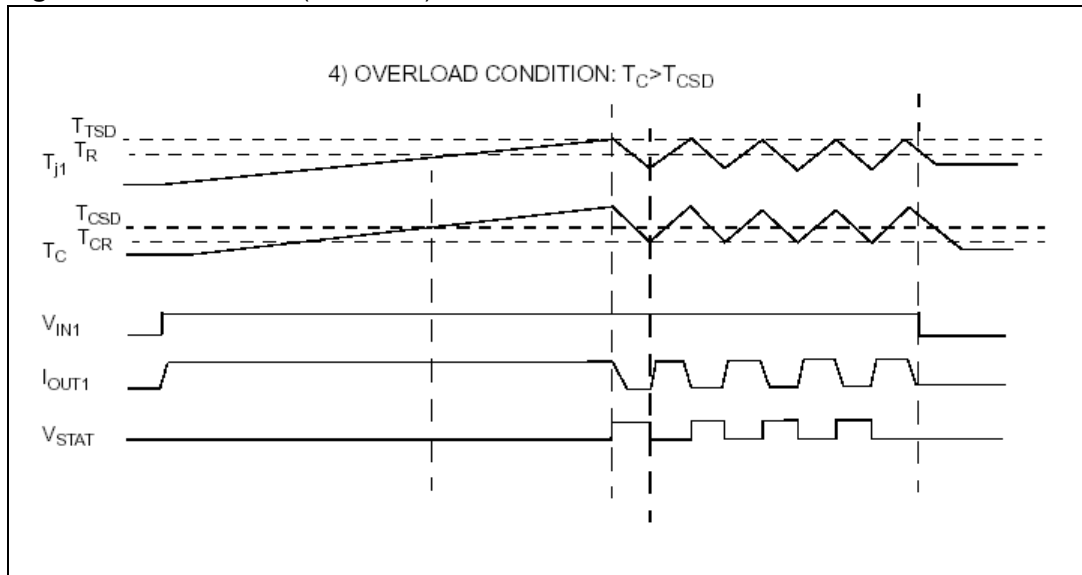
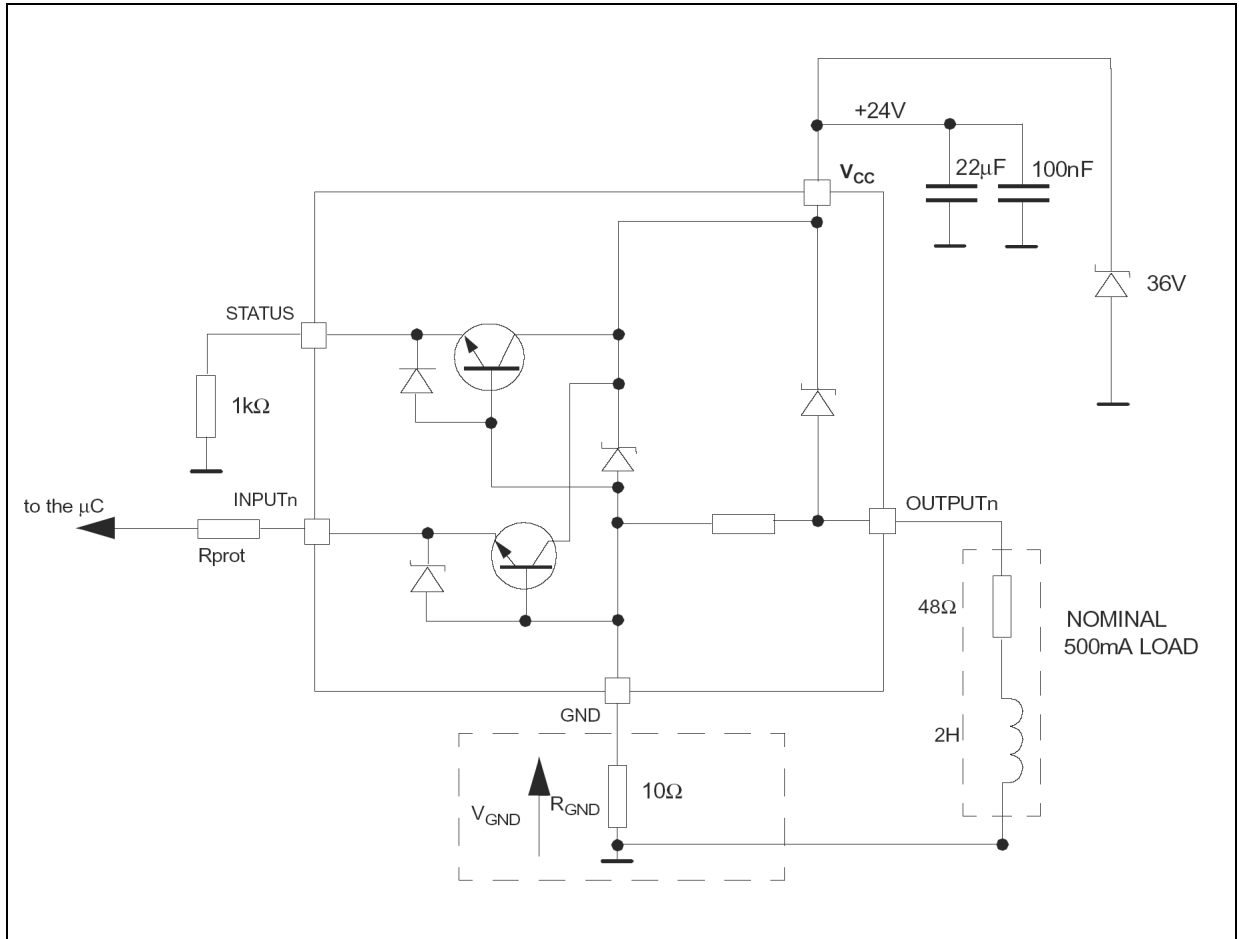


Figure 6. Waveforms (continued)



# 6 Application schematic

Figure 7. Application schematic



## 7 Reverse polarity protection

A schematic solution to protect the IC against a reverse polarity condition is proposed.

This schematic is effective with any type of load connected to the outputs of the IC.

The  $R_{GND}$  resistor value can be selected according to the following conditions to be met:

1.  $R_{GND} \leq 600 \text{ mV} / (I_S \text{ in ON state max})$ .
2.  $R_{GND} \geq (-V_{CC}) / (-I_{GND})$

where  $-I_{GND}$  is the DC reverse ground pin current and can be found in the absolute maximum rating section of the device datasheet.

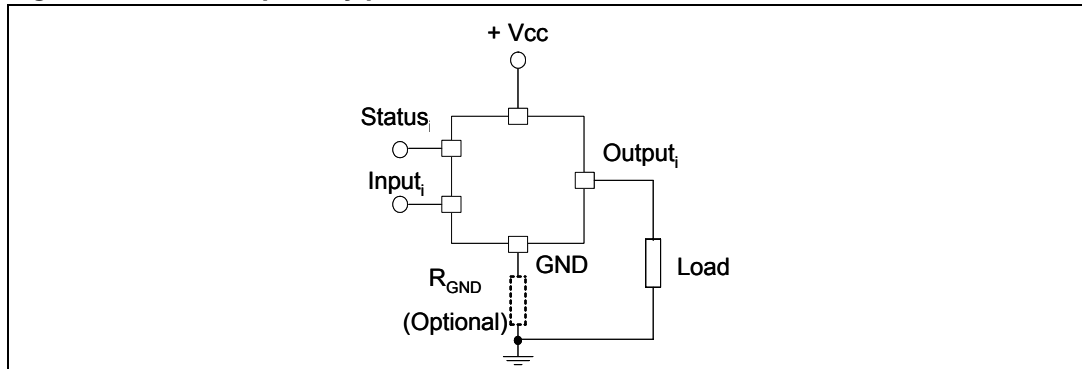
The power dissipation associated to  $R_{GND}$  during reverse polarity condition is:

$$PD = (-V_{CC})^2 / R_{GND}$$

This resistor can be shared by several different ICs. In such case  $I_S$  value on formula (1) is the sum of the maximum ON-state currents of the different devices.

Please note that if the microprocessor ground and the device ground are separated then the voltage drop across the  $R_{GND}$  (given by  $I_S$  in ON state max \*  $R_{GND}$ ) produce a difference between the generated input level and the IC input signal level. This voltage drop will vary depending on how many devices are ON in the case of several high side switches sharing the same  $R_{GND}$ .

**Figure 8. Reverse polarity protection**



## 8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

**Table 10. PowerSO-36 mechanical data**

| Dim.   | mm    |       |       | inch  |       |        |
|--------|-------|-------|-------|-------|-------|--------|
|        | Min.  | Typ.  | Max.  | Min.  | Typ.  | Max.   |
| A      |       |       | 3.60  |       |       | 0.1417 |
| a1     | 0.10  |       | 0.30  | 0.003 |       | 0.0118 |
| a2     |       |       | 3.30  |       |       | 0.1299 |
| a3     | 0     |       | 0.10  | 0     |       | 0.0039 |
| b      | 0.22  |       | 0.38  | 0.008 |       | 0.0150 |
| c      | 0.23  |       | 0.32  | 0.009 |       | 0.0126 |
| D (1)  | 15.80 |       | 16.00 | 0.622 |       | 0.6299 |
| D1     | 9.40  |       | 9.80  | 0.370 |       | 0.3858 |
| E      | 13.90 |       | 14.50 | 0.547 |       | 0.5709 |
| E1 (1) | 10.90 |       | 11.10 | 0.429 |       | 0.4370 |
| E2     |       |       | 2.90  |       |       | 0.1142 |
| E3     | 5.8   |       | 6.2   | 0.228 |       | 0.2441 |
| e      |       | 0.65  |       |       | 0.025 |        |
| e3     |       | 11.05 |       |       | 0.435 |        |
| G      | 0     |       | 0.10  | 0.000 |       | 0.0039 |
| H      | 15.50 |       | 15.90 | 0.610 |       | 0.6260 |
| h      |       |       | 1.10  |       |       | 0.0433 |
| L      | 0.80  |       | 1.10  | 0.031 |       | 0.0433 |
| N      |       |       | 10°   |       |       | 10°    |
| S      | 0°    |       | 8°    | 0°    |       | 8°     |

Figure 9. PowerSO-36 drawings

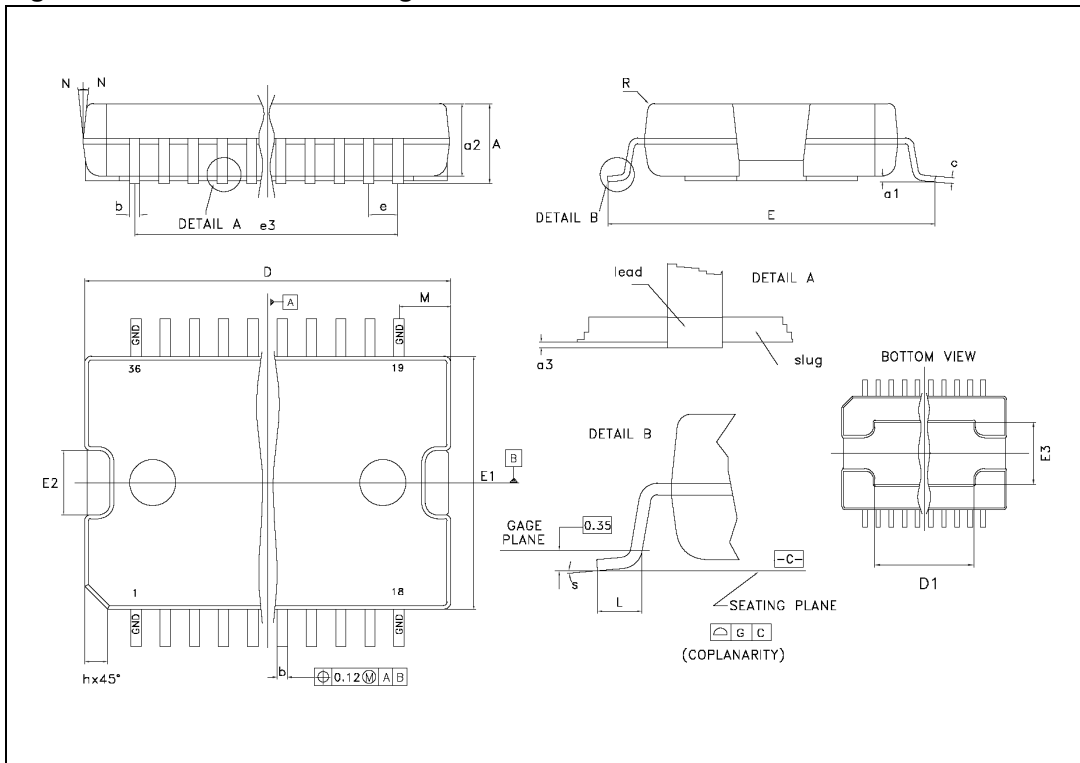
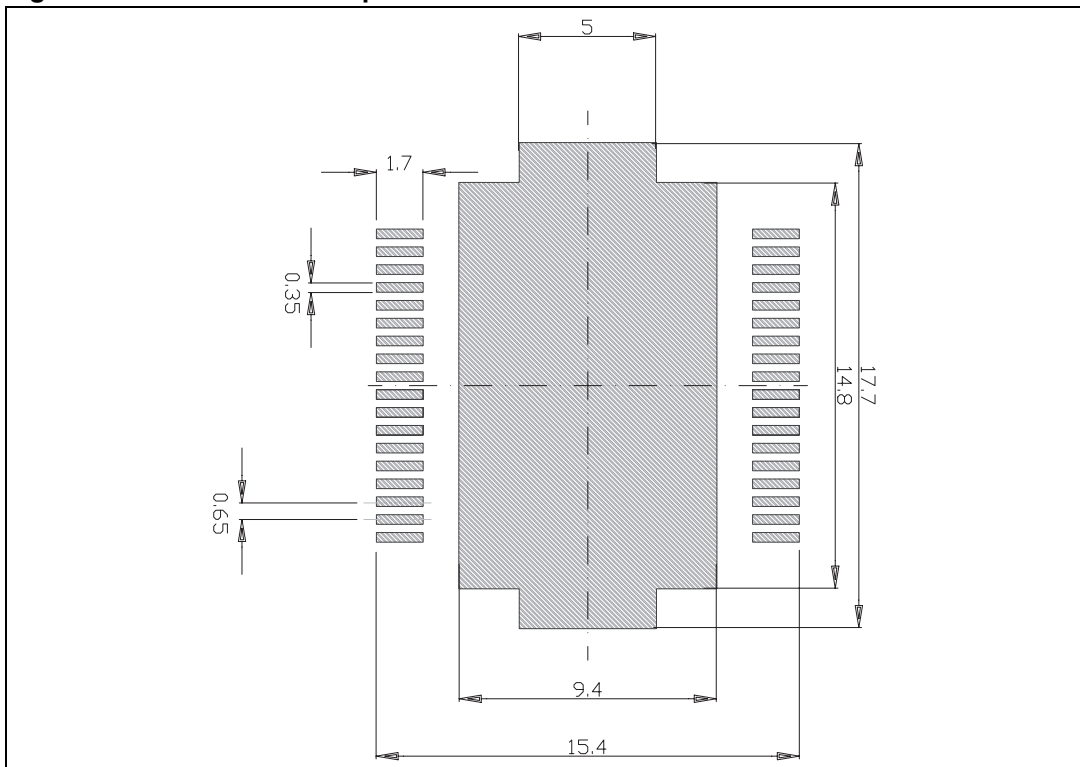


Figure 10. PowerSO-36 footprint



## 9 Order codes

**Table 11. Order codes**

| <b>Order codes</b> | <b>Package</b> | <b>Packaging</b> |
|--------------------|----------------|------------------|
| VN808CM-32-E       | PowerSO-36     | Tube             |
| VN808CMTR-32-E     | PowerSO-36     | Tape and reel    |



## 10 Revision history

**Table 12. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 28-Jun-2006 | 1        | Initial release   |
| 07-Aug-2008 | 2        | Added <i>Section 7 on page 13, Figure 10: PowerSO-36 footprint on page 15</i> |

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